

Excellence Award, AI Competition Sep 2025
DACON Inc. · **Korea Energy Agency (KEA)**
Power Consumption Forecasting AI Competition, 2025 [↗](#)

- Development of a large-scale electricity forecasting architecture combining hierarchical seasonal analysis and cluster-based representation learning. [↗](#)
- Awarded 2nd place out of 937 teams (Top 0.2%)

Institute for Information & Communications Technology Planning & Evaluation President's Award, AI Competition Aug 2025
SW-Centered University Digital Competition: AI Sector, 2025 [↗](#)

- Development of a multi-phase AI system for detecting LLM-generated text, integrating document-to-paragraph self-distillation and LLM-based data augmentation. [↗](#)
- Awarded 3rd place out of 271 teams (Top 1%)
- Winner of the Popularity Award

DB Kim Jun Ki Cultural Foundation Chairman's Award, Research Paper Competition May 2025
15th DB Insurance & Finance Contest, 2025 [↗](#)

- Authored a paper on anxiety sentiment and bond investment behavior using BERT.
- Awarded 5th place out of 546 teams (Top 0.9%)

Korea Intellectual Property Office Commissioner's Award, Idea Competition Aug 2023
National Defense Conundrum Solution Idea Competition

- Designed an AI-based system for mitigating acoustic noise in naval propulsion and maneuvering.
- Awarded 1st place

Scholarship

Presidential Science Scholarship, Engineering Mar 2025 - Present
President of the Republic of Korea

- Selected as one of 60 outstanding science and engineering students nationwide to receive full-tuition support and research funding.

Academic Excellence Scholarship for 2024 Spring Semester Aug 2024
College of Computing and Informatics, Sungkyunkwan University

- Achieved a 4.50/4.50 GPA for 17 Credits, Ranking in the Top 1%.

Student Success Scholarship (Leader) Feb 2024
Sungkyunkwan University

- Granted in recognition of leadership, initiative, and student engagement.

YulGok Scholarship Mar 2023 – Feb 2025
Sungkyunkwan University

- Awarded for 4 consecutive semesters based on outstanding academic achievement at admission.